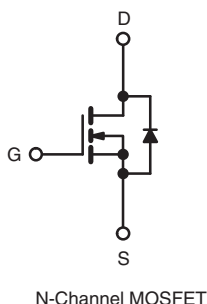
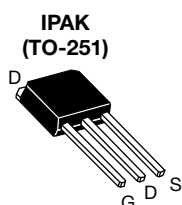


## D Series Power MOSFET

### PRODUCT SUMMARY

|                                         |                 |     |
|-----------------------------------------|-----------------|-----|
| $V_{DS}$ (V) at $T_J$ max.              | 550             |     |
| $R_{DS(on)}$ max. at 25 °C ( $\Omega$ ) | $V_{GS} = 10$ V | 1.5 |
| $Q_g$ (max.) (nC)                       | 20              |     |
| $Q_{gs}$ (nC)                           | 3               |     |
| $Q_{gd}$ (nC)                           | 5               |     |
| Configuration                           | Single          |     |



### FEATURES

- Optimal Design
  - Low Area Specific On-Resistance
  - Low Input Capacitance ( $C_{iss}$ )
  - Reduced Capacitive Switching Losses
  - High Body Diode Ruggedness
  - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
  - Low Cost
  - Simple Gate Drive Circuitry
  - Low Figure-of-Merit (FOM):  $R_{on} \times Q_g$
  - Fast Switching
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

### APPLICATIONS

- Consumer Electronics
  - Displays (LCD or Plasma TV)
- Server and Telecom Power Supplies
  - SMPS
- Industrial
  - Welding
  - Induction Heating
  - Motor Drives
- Battery Chargers



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
Available

### ORDERING INFORMATION

|                                 |               |
|---------------------------------|---------------|
| Package                         | IPAK (TO-251) |
| Lead (Pb)-free                  | SiHU5N50D-E3  |
| Lead (Pb)-free and Halogen-free | SiHU5N50D-GE3 |

### ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted)

| PARAMETER                                                 | SYMBOL         | LIMIT         | UNIT |
|-----------------------------------------------------------|----------------|---------------|------|
| Drain-Source Voltage                                      | $V_{DS}$       | 500           | V    |
| Gate-Source Voltage                                       | $V_{GS}$       | $\pm 30$      |      |
| Gate-Source Voltage AC ( $f > 1$ Hz)                      |                | 30            |      |
| Continuous Drain Current ( $T_J = 150$ °C)                | $I_D$          | 5.3           | A    |
| $V_{GS}$ at 10 V                                          |                | 3.4           |      |
| Pulsed Drain Current <sup>a</sup>                         | $I_{DM}$       | 10            |      |
| Linear Derating Factor                                    |                | 0.83          | W/°C |
| Single Pulse Avalanche Energy <sup>b</sup>                | $E_{AS}$       | 23            | mJ   |
| Maximum Power Dissipation                                 | $P_D$          | 104           | W    |
| Operating Junction and Storage Temperature Range          | $T_J, T_{stg}$ | - 55 to + 150 | °C   |
| Drain-Source Voltage Slope                                | $dV/dt$        | 24            | V/ns |
| Reverse Diode $dV/dt$ <sup>(d)</sup>                      |                | 0.28          |      |
| Soldering Recommendations (Peak Temperature) <sup>c</sup> |                | 300           | °C   |

#### Notes

- Repetitive rating; pulse width limited by maximum junction temperature.
- $V_{DD} = 50$  V, starting  $T_J = 25$  °C,  $L = 2.3$  mH,  $R_g = 25$   $\Omega$ ,  $I_{AS} = 4.5$  A.
- 1.6 mm from case.
- $I_{SD} \leq I_D$ , starting  $T_J = 25$  °C.

**THERMAL RESISTANCE RATINGS**

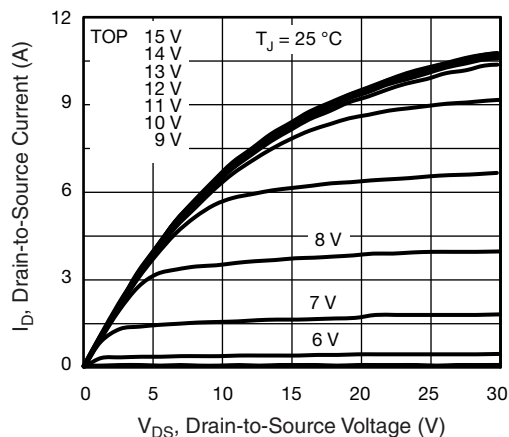
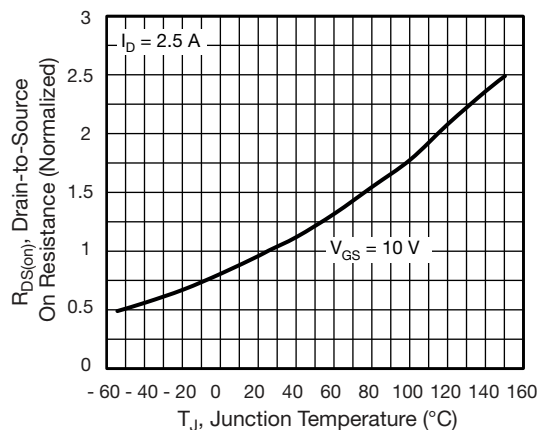
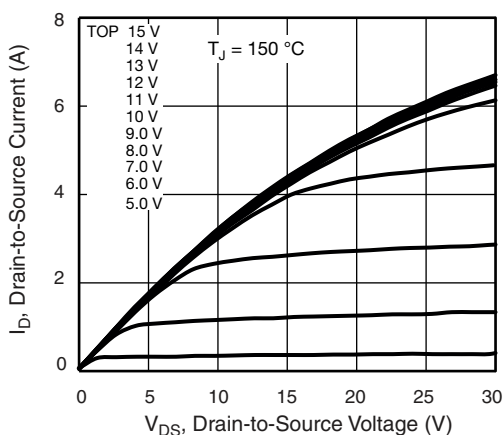
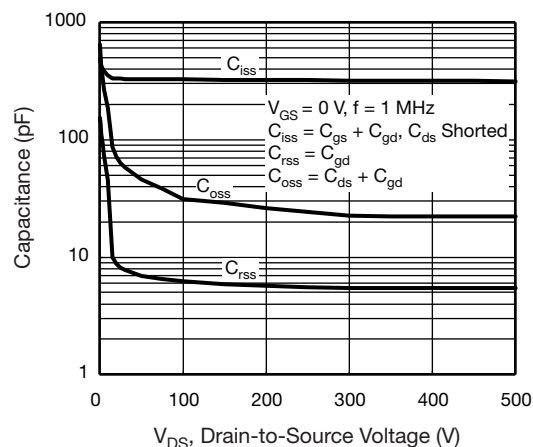
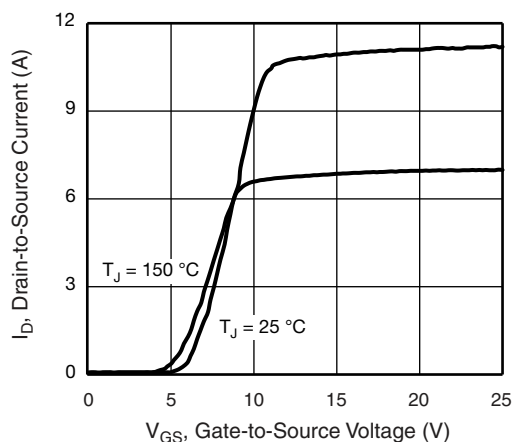
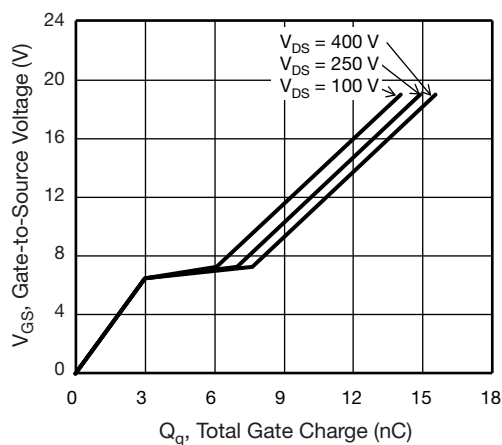
| PARAMETER                        | SYMBOL     | TYP. | MAX. | UNIT |
|----------------------------------|------------|------|------|------|
| Maximum Junction-to-Ambient      | $R_{thJA}$ | -    | 62   | °C/W |
| Maximum Junction-to-Case (Drain) | $R_{thJC}$ | -    | 1.2  |      |

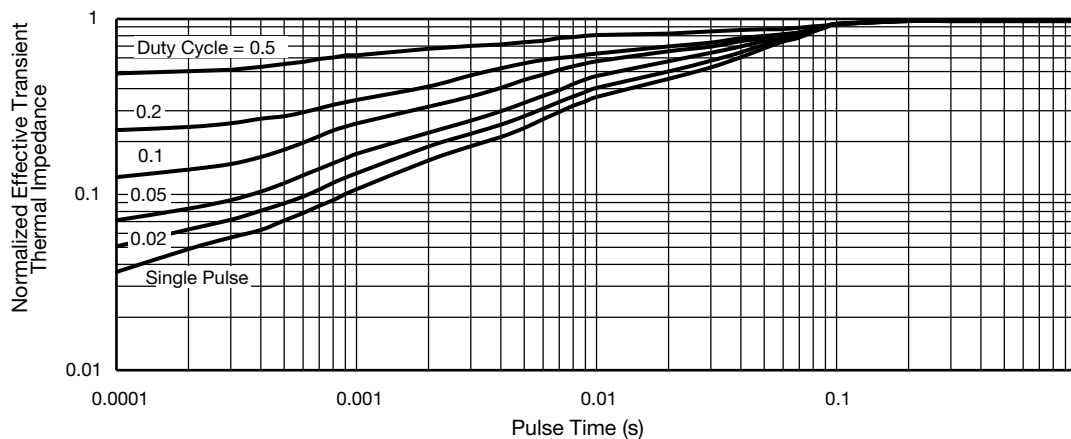
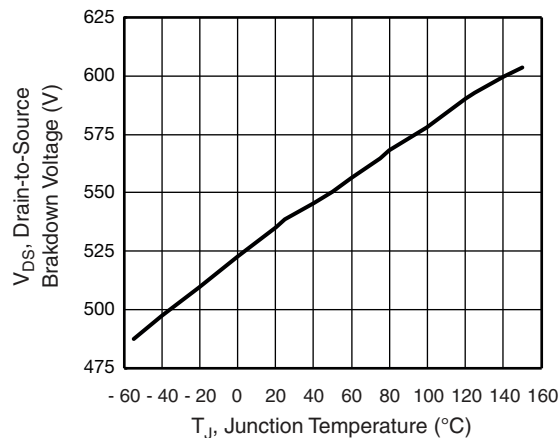
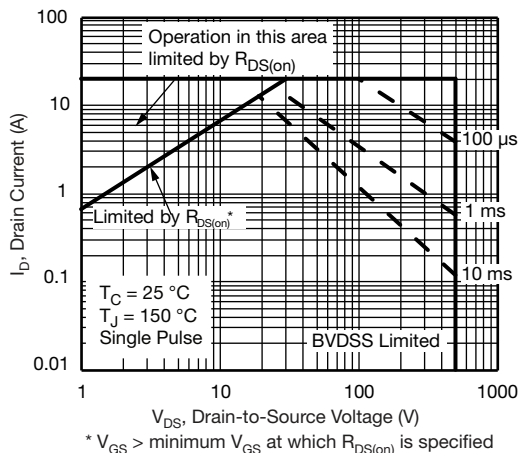
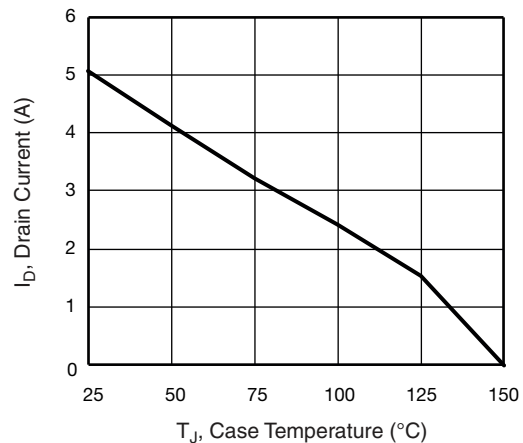
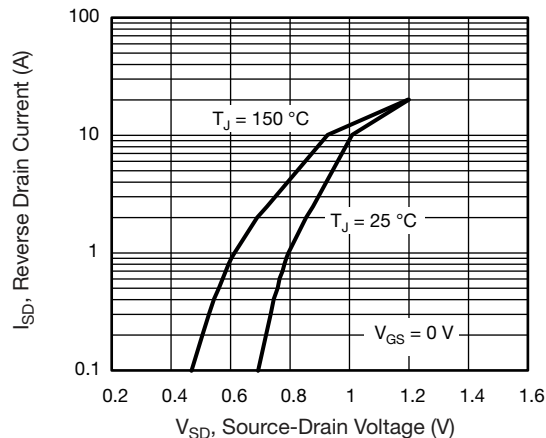
**SPECIFICATIONS** ( $T_J = 25^\circ\text{C}$ , unless otherwise noted)

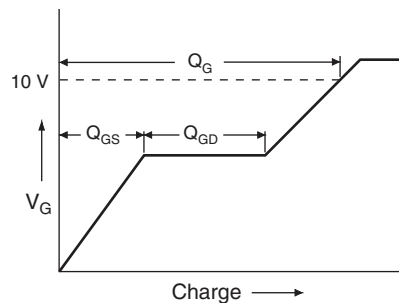
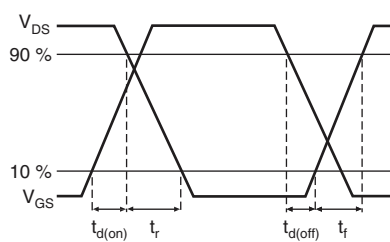
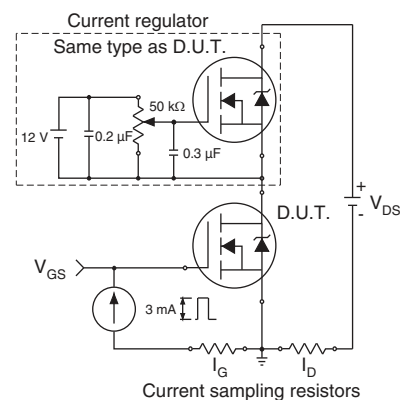
| PARAMETER                                                 | SYMBOL              | TEST CONDITIONS                                                                                                                                       | MIN. | TYP. | MAX.      | UNIT          |
|-----------------------------------------------------------|---------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|-----------|---------------|
| <b>Static</b>                                             |                     |                                                                                                                                                       |      |      |           |               |
| Drain-Source Breakdown Voltage                            | $V_{DS}$            | $V_{GS} = 0\text{ V}$ , $I_D = 250\text{ }\mu\text{A}$                                                                                                | 500  | -    | -         | V             |
| $V_{DS}$ Temperature Coefficient                          | $\Delta V_{DS}/T_J$ | Reference to $25^\circ\text{C}$ , $I_D = 250\text{ }\mu\text{A}$                                                                                      | -    | 0.58 | -         | V/°C          |
| Gate-Source Threshold Voltage (N)                         | $V_{GS(th)}$        | $V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$                                                                                                    | 3    | -    | 5         | V             |
| Gate-Source Leakage                                       | $I_{GSS}$           | $V_{GS} = \pm 30\text{ V}$                                                                                                                            | -    | -    | $\pm 100$ | nA            |
| Zero Gate Voltage Drain Current                           | $I_{DSS}$           | $V_{DS} = 500\text{ V}$ , $V_{GS} = 0\text{ V}$                                                                                                       | -    | -    | 1         | $\mu\text{A}$ |
|                                                           |                     | $V_{DS} = 400\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 125^\circ\text{C}$                                                                           | -    | -    | 10        |               |
| Drain-Source On-State Resistance                          | $R_{DS(on)}$        | $V_{GS} = 10\text{ V}$ , $I_D = 2.5\text{ A}$                                                                                                         | -    | 1.2  | 1.5       | $\Omega$      |
| Forward Transconductance <sup>a</sup>                     | $g_{fs}$            | $V_{DS} = 20\text{ V}$ , $I_D = 2.5\text{ A}$                                                                                                         | -    | 1.8  | -         | S             |
| <b>Dynamic</b>                                            |                     |                                                                                                                                                       |      |      |           |               |
| Input Capacitance                                         | $C_{iss}$           | $V_{GS} = 0\text{ V}$ ,<br>$V_{DS} = 100\text{ V}$ ,<br>$f = 1\text{ MHz}$                                                                            | -    | 325  | -         | pF            |
| Output Capacitance                                        | $C_{oss}$           |                                                                                                                                                       | -    | 34   | -         |               |
| Reverse Transfer Capacitance                              | $C_{rss}$           |                                                                                                                                                       | -    | 6    | -         |               |
| Effective Output Capacitance, Energy Related <sup>b</sup> | $C_{o(er)}$         | $V_{DS} = 0\text{ V to } 400\text{ V}$ , $V_{GS} = 0\text{ V}$                                                                                        | -    | 31   | -         |               |
| Effective Output Capacitance, Time Related <sup>c</sup>   | $C_{o(tr)}$         |                                                                                                                                                       | -    | 41   | -         |               |
| Total Gate Charge                                         | $Q_g$               | $V_{GS} = 10\text{ V}$ ,<br>$I_D = 2.5\text{ A}$ , $V_{DS} = 400\text{ V}$                                                                            | -    | 10   | 20        | nC            |
| Gate-Source Charge                                        | $Q_{gs}$            |                                                                                                                                                       | -    | 3    | -         |               |
| Gate-Drain Charge                                         | $Q_{gd}$            |                                                                                                                                                       | -    | 5    | -         |               |
| Turn-On Delay Time                                        | $t_{d(on)}$         | $V_{DD} = 400\text{ V}$ , $I_D = 2.5\text{ A}$ ,<br>$R_g = 9.1\text{ }\Omega$ , $V_{GS} = 10\text{ V}$                                                | -    | 12   | 24        | ns            |
| Rise Time                                                 | $t_r$               |                                                                                                                                                       | -    | 11   | 22        |               |
| Turn-Off Delay Time                                       | $t_{d(off)}$        |                                                                                                                                                       | -    | 14   | 28        |               |
| Fall Time                                                 | $t_f$               |                                                                                                                                                       | -    | 11   | 22        |               |
| Gate Input Resistance                                     | $R_g$               | $f = 1\text{ MHz}$ , open drain                                                                                                                       | -    | 1.7  | -         | $\Omega$      |
| <b>Drain-Source Body Diode Characteristics</b>            |                     |                                                                                                                                                       |      |      |           |               |
| Continuous Source-Drain Diode Current                     | $I_S$               | MOSFET symbol showing the integral reverse P - N junction diode  | -    | -    | 5         | A             |
| Pulsed Diode Forward Current                              | $I_{SM}$            |                                                                                                                                                       | -    | -    | 20        |               |
| Diode Forward Voltage                                     | $V_{SD}$            | $T_J = 25^\circ\text{C}$ , $I_S = 4\text{ A}$ , $V_{GS} = 0\text{ V}$                                                                                 | -    | -    | 1.2       | V             |
| Reverse Recovery Time                                     | $t_{rr}$            | $T_J = 25^\circ\text{C}$ , $I_F = I_S = 2.5\text{ A}$ ,<br>$di/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 20\text{ V}$                                   | -    | 320  | -         | ns            |
| Reverse Recovery Charge                                   | $Q_{rr}$            |                                                                                                                                                       | -    | 1.2  | -         | $\mu\text{C}$ |
| Reverse Recovery Current                                  | $I_{RRM}$           |                                                                                                                                                       | -    | 8    | -         | A             |

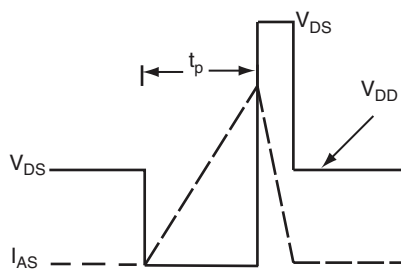
**Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature.  
b.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .  
c.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

**Fig. 1 - Typical Output Characteristics**

**Fig. 4 - Normalized On-Resistance vs. Temperature**

**Fig. 2 - Typical Output Characteristics**

**Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage**

**Fig. 3 - Typical Transfer Characteristics**

**Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage**




**Fig. 12 - Switching Time Test Circuit**

**Fig. 16 - Basic Gate Charge Waveform**

**Fig. 13 - Switching Time Waveforms**

**Fig. 17 - Gate Charge Test Circuit**

**Fig. 14 - Unclamped Inductive Test Circuit**

**Fig. 15 - Unclamped Inductive Waveforms**

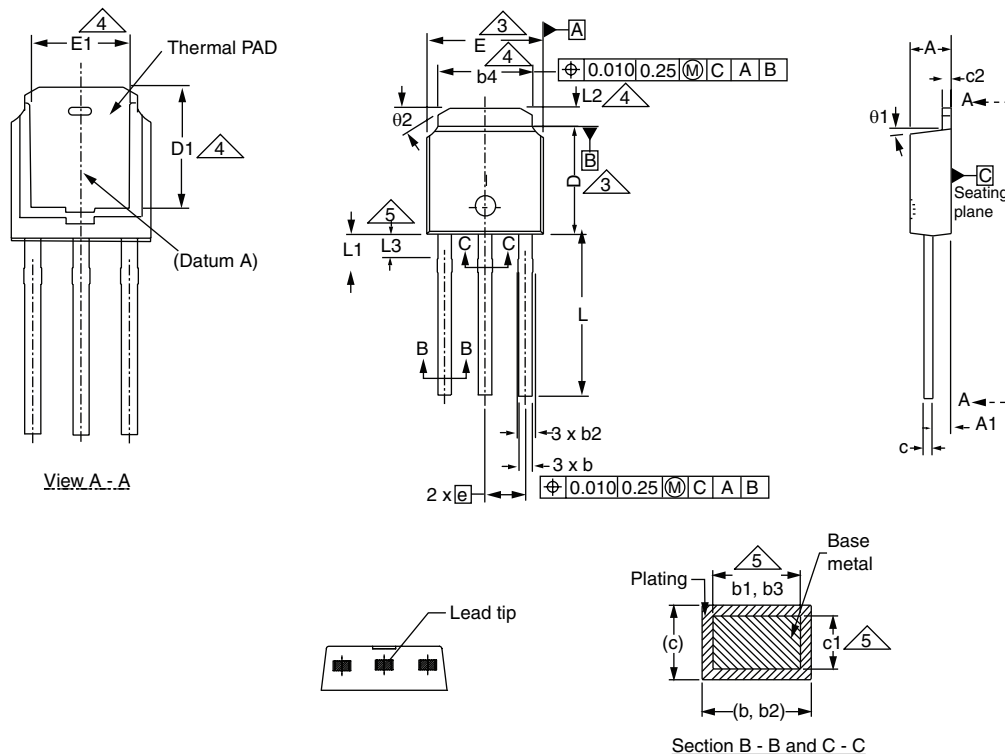

**Note**

a.  $V_{GS} = 5 V$  for logic level devices

**Fig. 18 - For N-Channel**

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see [www.vishay.com/ppg?91492](http://www.vishay.com/ppg?91492).

## TO-251AA (HIGH VOLTAGE)



| DIM. | MILLIMETERS |      | INCHES |       |
|------|-------------|------|--------|-------|
|      | MIN.        | MAX. | MIN.   | MAX.  |
| A    | 2.18        | 2.39 | 0.086  | 0.094 |
| A1   | 0.89        | 1.14 | 0.035  | 0.045 |
| b    | 0.64        | 0.89 | 0.025  | 0.035 |
| b1   | 0.65        | 0.79 | 0.026  | 0.031 |
| b2   | 0.76        | 1.14 | 0.030  | 0.045 |
| b3   | 0.76        | 1.04 | 0.030  | 0.041 |
| b4   | 4.95        | 5.46 | 0.195  | 0.215 |
| c    | 0.46        | 0.61 | 0.018  | 0.024 |
| c1   | 0.41        | 0.56 | 0.016  | 0.022 |
| c2   | 0.46        | 0.86 | 0.018  | 0.034 |
| D    | 5.97        | 6.22 | 0.235  | 0.245 |

| DIM. | MILLIMETERS |      | INCHES   |       |
|------|-------------|------|----------|-------|
|      | MIN.        | MAX. | MIN.     | MAX.  |
| D1   | 5.21        | -    | 0.205    | -     |
| E    | 6.35        | 6.73 | 0.250    | 0.265 |
| E1   | 4.32        | -    | 0.170    | -     |
| e    | 2.29 BSC    |      | 2.29 BSC |       |
| L    | 8.89        | 9.65 | 0.350    | 0.380 |
| L1   | 1.91        | 2.29 | 0.075    | 0.090 |
| L2   | 0.89        | 1.27 | 0.035    | 0.050 |
| L3   | 1.14        | 1.52 | 0.045    | 0.060 |
| θ1   | 0°          | 15°  | 0°       | 15°   |
| θ2   | 25°         | 35°  | 25°      | 35°   |

ECN: S-82111-Rev. A, 15-Sep-08  
DWG: 5968

### Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.
2. Dimension are shown in inches and millimeters.
3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
5. Lead dimension uncontrolled in L3.
6. Dimension b1, b3 and c1 apply to base metal only.
7. Outline conforms to JEDEC outline TO-251AA.



## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

## Material Category Policy

**Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.**

**Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.**



**Стандарт  
Электрон  
Связь**

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России , а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научно-исследовательскими институтами России.

С нами вы становитесь еще успешнее!

**Наши контакты:**

**Телефон:** +7 812 627 14 35

**Электронная почта:** [sales@st-electron.ru](mailto:sales@st-electron.ru)

**Адрес:** 198099, Санкт-Петербург,  
Промышленная ул, дом № 19, литера Н,  
помещение 100-Н Офис 331